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With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



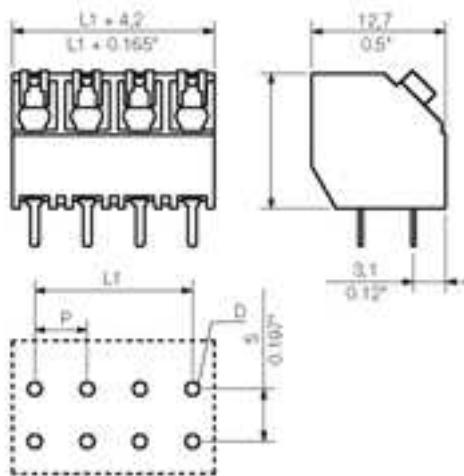
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General ordering data

Order No.	1884870000
Part designation	LSF-SMT5.08/16/135 1.5
Version	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 16, 135°, Tube
EAN	4032248489541
Qty.	6 pc(s).

System parameters

Product family	System LS
Conductor connection system	Push In
Fitted to PCB	Reflow solder connection
Outgoing direction of conductor	135°
Pitch	5.08 mm
Pitch in inch	0.2 inch
No. of poles	16
Fitted by customer	yes
No. of rows	1
Solder pin length	1.5 mm
Dia. of fitting hole	1.1 mm
Fitting hole tolerance	+ 0.1 mm
No. of solder pins per pole	2
Stripping length	8 mm

System parameters

L1 in mm	76.2 mm
L1 in inch	3 inch
Electric shock protection to DIN VDE 0470	IP 20
Electric shock protection to DIN VDE 0470	Safe from finger touch

Material data

Insulating material	LCP GF
Colour	black
colour chart	Similar to RAL 9011
Insulating material group	IIIa
Flammability class UL 94	V-0
CTI	>= 175
Contact base material	Copper alloy
Contact surface	tinned
Storage temperature, min.	-25 °C
Storage temperature, max.	55 °C

Connectable conductors

Clamping range, min.	0.13 mm ²
Clamping range, max.	1.5 mm ²
AWG, min.	24
AWG, max.	16
O.D. of conductor insulation, max.	2.9 mm
Solid, min. H05(07) V-U	0.2 mm ²
Solid, max. H05(07) V-U	1.5 mm ²
Flexible, min. H05(07) V-K	0.2 mm ²
Flexible, max. H05(07) V-K	1.5 mm ²
With wire end ferrule, acc. to DIN 46 228/1, min.	0.25 mm ²
With wire end ferrule, acc. to DIN 46 228/1, max.	1.5 mm ²
w. plastic collar ferrule, DIN 46228 pt 4, min.	0.25 mm ²
w. plastic collar ferrule, DIN 46228 pt 4, max.	0.75 mm ²

DIN IEC rating data

Rated current, min. No. pins (Tu=20°C)	17.5 A
Rated current, max. No. pins (Tu=20°C)	17.5 A
Rated current, min. No. pins (Tu=40°C)	17.5 A
Rated current, max. No. pins (Tu=40°C)	15 A
Rated voltage for overvoltage class/pollution severity II/2	500 V
Rated voltage for overvoltage class/pollution severity III/2	320 V
Rated voltage for overvoltage class/pollution severity III/3	250 V
Rated impulse withstand voltage for overvoltage class/pollution severity II/2	4 kV
Rated impulse withstand voltage for overvoltage class/pollution severity III/2	4 kV
Rated impulse withstand voltage for overvoltage class/pollution severity III/3	4 kV
Short-time withstand current resistance	3 x 1s with 80 A

CSA rating data

Rated voltage (Use group D)	300 V
Rated current (Use group D)	10 A
AWG conductor (field wiring), min.	24
AWG conductor (field wiring), max.	16

UL 1059 rating data

Rated voltage (Use group D)	300 V
Rated current (Use group D)	10 A
AWG conductor, min.	24
AWG conductor, max.	16

Approvals

Approvals institutes



Classifications

eClass 5.1	27-26-11-01
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Similar products

Order No.	Part designation	Version
1885020000	LSF-SMT5.08/2/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 2, 135°, Tube
1888780000	LSF-SMT5.08/2/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 2, 135°, Tape
1884730000	LSF-SMT5.08/2/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 2, 135°, Tube
1888710000	LSF-SMT5.08/2/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 2, 135°, Tape
1885030000	LSF-SMT5.08/3/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 3, 135°, Tube
1888790000	LSF-SMT5.08/3/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 3, 135°, Tape
1884740000	LSF-SMT5.08/3/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 3, 135°, Tube
1888720000	LSF-SMT5.08/3/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 3, 135°, Tape
1885040000	LSF-SMT5.08/4/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 4, 135°, Tube
1888810000	LSF-SMT5.08/4/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 4, 135°, Tape
1884750000	LSF-SMT5.08/4/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 4, 135°, Tube
1888730000	LSF-SMT5.08/4/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 4, 135°, Tape

1885050000	LSF-SMT5.08/5/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 5, 135°, Tube
1888830000	LSF-SMT5.08/5/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 5, 135°, Tape
1884760000	LSF-SMT5.08/5/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 5, 135°, Tube
1888740000	LSF-SMT5.08/5/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 5, 135°, Tape
1885060000	LSF-SMT5.08/6/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 6, 135°, Tube
1888840000	LSF-SMT5.08/6/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 6, 135°, Tape
1884770000	LSF-SMT5.08/6/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 6, 135°, Tube
1888750000	LSF-SMT5.08/6/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 6, 135°, Tape
1885070000	LSF-SMT5.08/7/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 7, 135°, Tube
1888870000	LSF-SMT5.08/7/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 7, 135°, Tape
1884780000	LSF-SMT5.08/7/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 7, 135°, Tube
1888760000	LSF-SMT5.08/7/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 7, 135°, Tape
1885080000	LSF-SMT5.08/8/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 8, 135°, Tube
1888880000	LSF-SMT5.08/8/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 8, 135°, Tape
1884790000	LSF-SMT5.08/8/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 8, 135°, Tube
1888770000	LSF-SMT5.08/8/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 8, 135°, Tape
1885090000	LSF-SMT5.08/9/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 9, 135°, Tube
1884800000	LSF-SMT5.08/9/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 9, 135°, Tube
1885100000	LSF-SMT5.08/10/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 10, 135°, Tube
1884810000	LSF-SMT5.08/10/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 10, 135°, Tube
1885110000	LSF-SMT5.08/11/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 11, 135°, Tube
1884820000	LSF-SMT5.08/11/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 11, 135°, Tube
1885120000	LSF-SMT5.08/12/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 12, 135°, Tube
1884830000	LSF-SMT5.08/12/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 12, 135°, Tube
1885130000	LSF-SMT5.08/13/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 13, 135°, Tube
1884840000	LSF-SMT5.08/13/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 13, 135°, Tube

1885150000	LSF-SMT5.08/15/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 15, 135°, Tube
1884860000	LSF-SMT5.08/15/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 15, 135°, Tube
1885140000	LSF-SMT5.08/14/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 14, 135°, Tube
1884850000	LSF-SMT5.08/14/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 14, 135°, Tube
1885160000	LSF-SMT5.08/16/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 5.08 mm, No. of poles: 16, 135°, Tube